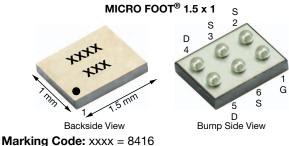
## Si8416DB **Vishay Siliconix**



N-Channel 8 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (TYP.)		
8	0.023 at V <sub>GS</sub> = 4.5 V	16			
	0.025 at V <sub>GS</sub> = 2.5 V	16			
	0.030 at V <sub>GS</sub> = 1.8 V	16	17 nC		
	0.040 at V <sub>GS</sub> = 1.5 V	15			
	0.095 at V <sub>GS</sub> = 1.2 V	3			



xxx = Date / lot traceability code

#### **Ordering Information:**

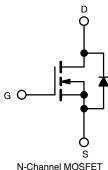
Si8416DB-T2-E1 (Lead (Pb)-free and halogen-free)

#### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- Ultra-small 1.5 mm x 1 mm maximum outline
- Ultra-thin 0.59 mm maximum height
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Low on-resistance load switch for portable devices
  - Low power consumption,
  - low voltage drop
  - Increased battery life
  - Space Saving on PCB



PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	8	V	
Gate-Source Voltage		V <sub>GS</sub>	± 5		
	T <sub>C</sub> = 25 °C		16 <sup>e</sup>		
	T <sub>C</sub> = 70 °C		16 <sup>e</sup>		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9.3 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		7.4 <sup>a, b</sup>	А	
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	20	1	
Continuous Courses Drain Diada Current	T <sub>C</sub> = 25 °C		11		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.3 <sup>a, b</sup>		
	T <sub>C</sub> = 25 °C		13		
Mauinum Daura Diasinatian	T <sub>C</sub> = 70 °C		8.4		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.77 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C		1.77 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	℃	
Package Reflow Conditions <sup>c</sup>	IR/Convection		260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient a, f		R <sub>thJA</sub>	37	45	°C/W	
Maximum Junction-to-Case (Drain) <sup>g</sup>	Steady State	R <sub>thJC</sub>	7	9.5	0/10	

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

Notes

c. Refer to IPC/JEDEC® (J-STD-020), no manual or hand soldering.

d. Case in defined as the top surface of the package.

e.  $T_C = 25$  °C package limited.

Maximum under steady state conditions is 85 °C/W. f.

g. Case is defined as top surface of the package.

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1 For technical questions, contact: pmostechsupport@vishay.com

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Si8416DB

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static						1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$	8	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	$\Delta V_{DS}/T_J$		2.2	-		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-2.7	-	mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.35	-	0.80	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V},  V_{GS} = \pm 5 \text{ V}$	-	-	± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = 8 V, V_{GS} = 0 V$	-	-	1	1 10 μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 8 V, V_{GS} = 0 V, T_{J} = 70 °C$	-	-	10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 5 \text{ V},  V_{GS} = 4.5 \text{ V}$	5	-	-	Α	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 1.5 \text{ A}$	-	0.019	0.023		
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	-	0.021	0.025		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	-	0.023	0.030	Ω	
		$V_{GS} = 1.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	0.027	0.040		
		$V_{GS} = 1.2 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	0.040	0.095		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 4 \text{ V}, \text{ I}_{D} = 1.5 \text{ A}$	-	22	-	S	
Dynamic <sup>b</sup>		·			•		
Input Capacitance	Ciss		-	1470	-	pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 4 V$ , $V_{GS} = 0 V$ , f = 1 MHz	-	580	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	450	-		
Total Gate Charge	Qg		-	17	26	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 1.5 \text{ A}$	-	1.8	-		
Gate-Drain Charge	Q <sub>gd</sub>		-	3.4	-		
Gate Resistance	Rg	$V_{GS} = 0.1 V, f = 1 MHz$	-	2.5	-	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>		-	13	25		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 4 V, $R_L$ = 2.7 $\Omega$	-	15	30	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 1.5 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	-	40	80		
Fall Time	t <sub>f</sub>		-	10	20		
Drain-Source Body Diode Characteri	stics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	20	А	
Pulse Diode Forward Current	I <sub>SM</sub>		-	-	20		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1.5 A, V <sub>GS</sub> = 0		0.7	1.2	V	
Body Diode Reverse Recovery Time t <sub>rr</sub>			-	35	70	ns	
Body Diode Reverse Recovery Charge Q <sub>rr</sub>		-	18	35	nC		
Reverse Recovery Fall Time	$I_{\rm E} = 1.5 \text{ A}$ , dl/dt = 100 A/us, $I_{\rm T} = 25 \text{ °C}$		-	13	-	ns	
Reverse Recovery Rise Time	t <sub>b</sub>	t <sub>b</sub>		22	-		

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

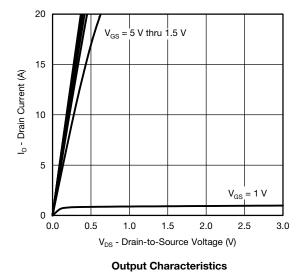
2

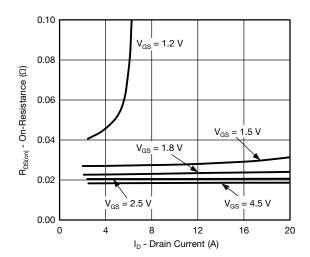
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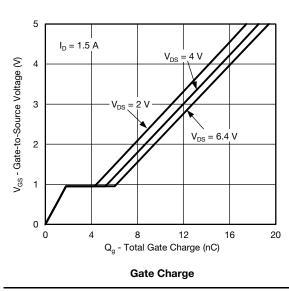
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



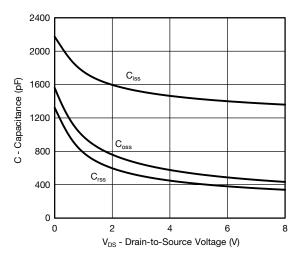


**On-Resistance vs. Drain Current and Gate Voltage** 

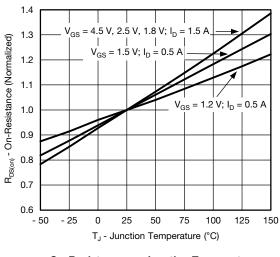


10 8 I<sub>D</sub> - Drain Current (A) 6 T<sub>C</sub> = 25 °C 4 125 °C 2 T<sub>C</sub> = - 55 °C 0 0.0 0.2 0.4 0.6 0.8 1.0 1.6 1.2 1.4 V<sub>GS</sub> - Gate-to-Source Voltage (V)

Transfer Characteristics







On-Resistance vs. Junction Temperature

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3

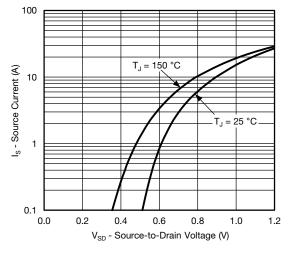
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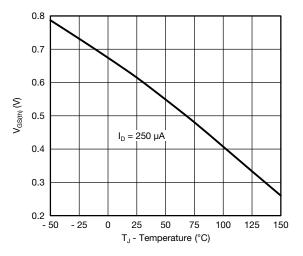




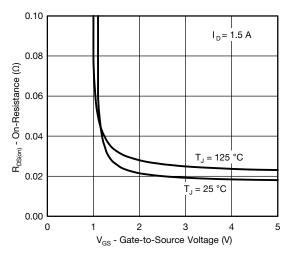
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



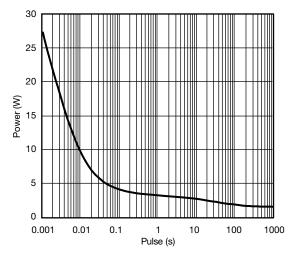
Source-Drain Diode Forward Voltage



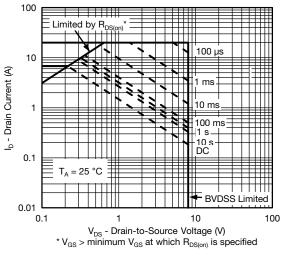
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient

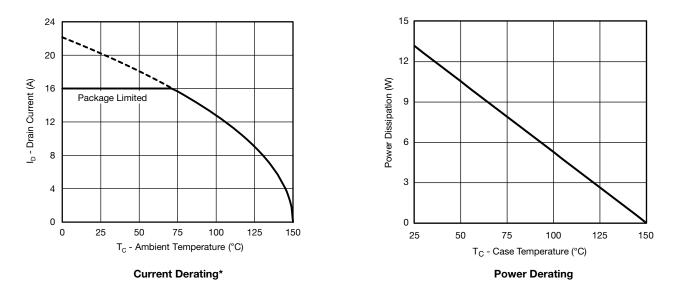


### Safe Operating Area, Junction-to-Ambient 4

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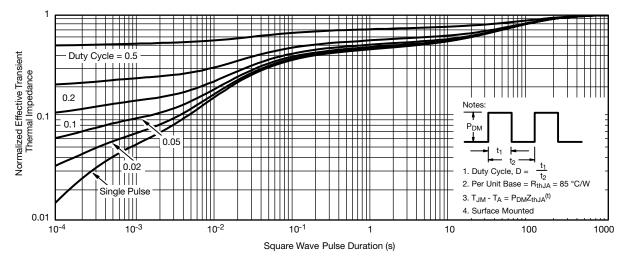
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



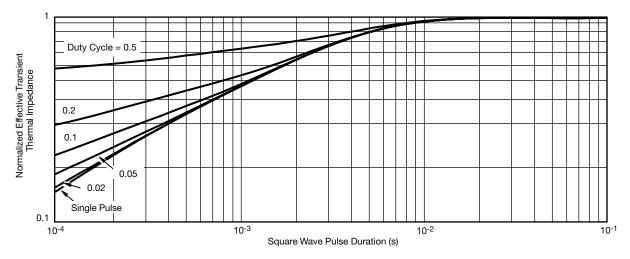
\* The power dissipation P<sub>D</sub> is based on T<sub>J</sub> (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

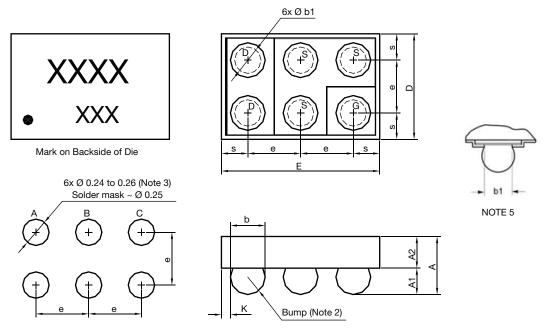


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63716.



## MICRO FOOT<sup>®</sup>: 6-Bump (1.5 mm x 1 mm, 0.5 mm Pitch, 0.250 mm Bump Height)



**Recommended Land Pattern** 

#### Notes

(unless otherwise specified)

- 1. Six (6) solder bumps are 95.5/3.8/0.7 Sn/Ag/Cu.
- 2. Backside surface is coated with a Ti/Ni/Ag layer.
- 3. Non-solder mask defined copper landing pad.
- 4. Laser marks on the silicon die back.
- 5. "b1" is the diameter of the solderable substrate surface, defined by an opening in the solder resist layer solder mask defined.

6. • is the location of pin 1

DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.510	0.575	0.590	0.0201	0.0226	0.0232	
A <sub>1</sub>	0.220	0.250	0.280	0.0087	0.0098	0.0110	
A <sub>2</sub>	0.290	0.300	0.310	0.0114	0.0118	0.0122	
b	0.297	0.330	0.363	0.0116	0.0129	0.0143	
b1	0.250			0.0098			
е		0.500			0.0197		
S	0.210	0.230	0.250	0.0082	0.0090	0.0098	
D	0.920	0.960	1.000	0.0362	0.0378	0.0394	
E	1.420	1.460	1.500	0.0559	0.0575	0.0591	
К	0.028	0.065	0.102	0.0011	0.0025	0.0040	

#### Note

· Use millimeters as the primary measurement.

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Revison: 20-Apr-15

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